

**General Description:**

The LW04N90A9 uses advanced VDMOS technology and design to provide excellent  $R_{DS(ON)}$  with low gate charge. It can be used in a wide variety of applications. The package form is TO-220F, which accords with the ROHS standard.

**Features:**

- Fast Switching
- Low Gate Charge and  $R_{dson}$
- Low Reverse transfer capacitances

**Applications:**

- Power switching application
- Hard switched and high frequency circuits

**100% DVDS Tested**

**100% Avalanche Tested**

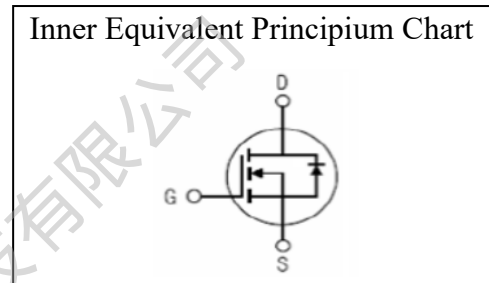
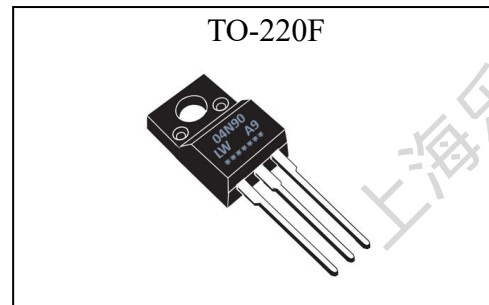

**Package Marking and Ordering Information:**

Marking	Part #	Package	Packing	Qty.
LW04N90A9	LW04N90A9	TO-220F	Tube	50units

**Absolute Maximum Ratings** ( $T_c = 25^\circ\text{C}$  unless otherwise specified):

Symbol	Parameter	Rating	Units
$V_{DSS}$	Drain-to-Source Voltage	900	V
$I_D$	Continuous Drain Current	4.0	A
	Continuous Drain Current $T_C = 100^\circ\text{C}$	2.5	A
$I_{DM}^{a1}$	Pulsed Drain Current	16	A
$V_{GS}$	Gate-to-Source Voltage	$\pm 30$	V
$E_{AS}^{a2}$	Single Pulse Avalanche Energy	240	mJ
$P_D$	Power Dissipation	36	W
$T_J, T_{STG}$	Operating Junction and Storage Temperature Range	150, -55 to 150	$^\circ\text{C}$
$T_L$	Maximum Temperature for Soldering	260	$^\circ\text{C}$

$V_{DSS}$	900	V
$I_D$	4	A
$P_D$ ( $T_C = 25^\circ\text{C}$ )	36	W
$R_{DS(ON)}$ TYPE	2.8	$\Omega$



**Electrical Characteristics** (Tc= 25°C unless otherwise specified) :

<b>OFF Characteristics</b>						
Symbol	Parameter	Test Conditions	Rating			Units
			Min.	Typ.	Max.	
V <sub>DSS</sub>	Drain to Source Breakdown Voltage	V <sub>GS</sub> =0V, I <sub>D</sub> =250μA	900	--	--	V
I <sub>DSS</sub>	Drain to Source Leakage Current	V <sub>DS</sub> = 900V, V <sub>GS</sub> = 0V, T <sub>a</sub> = 25°C	--	--	1	μA
		V <sub>DS</sub> =720V, V <sub>GS</sub> = 0V, T <sub>a</sub> = 125°C	--	--	10	
I <sub>GSS(F)</sub>	Gate to Source Forward Leakage	V <sub>GS</sub> =+30V	--	--	100	nA
I <sub>GSS(R)</sub>	Gate to Source Reverse Leakage	V <sub>GS</sub> =-30V	--	--	-100	nA

<b>ON Characteristics</b>						
Symbol	Parameter	Test Conditions	Rating			Units
			Min.	Typ.	Max.	
R <sub>DS(ON)</sub>	Drain-to-Source On-Resistance	V <sub>GS</sub> =10V, I <sub>D</sub> =2.0A	--	2.8	3.2	Ω
V <sub>GS(TH)</sub>	Gate Threshold Voltage	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250μA	3		5	V
Pulse width tp≤380μs, δ≤2%						

<b>Dynamic Characteristics</b>						
Symbol	Parameter	Test Conditions	Rating			Units
			Min.	Typ.	Max.	
g <sub>fs</sub>	Forward Transconductance	V <sub>DS</sub> =40V, I <sub>D</sub> =2A	--	2.5	--	S
C <sub>iss</sub>	Input Capacitance	V <sub>GS</sub> = 0V V <sub>DS</sub> = 25V f = 1.0MHz	--	700	--	pF
C <sub>oss</sub>	Output Capacitance		--	58	--	
C <sub>rss</sub>	Reverse Transfer Capacitance		--	5	--	

<b>Resistive Switching Characteristics</b>						
Symbol	Parameter	Test Conditions	Value			Units
			Min.	Typ.	Max.	
t <sub>d(ON)</sub>	Turn-on Delay Time	I <sub>D</sub> =4A V <sub>DS</sub> = 400V R <sub>G</sub> = 25Ω	--	16	--	ns
t <sub>r</sub>	Rise Time		--	14	--	
t <sub>d(OFF)</sub>	Turn-Off Delay Time		--	40	--	
t <sub>f</sub>	Fall Time		--	12	--	
Q <sub>g</sub>	Total Gate Charge	V <sub>GS</sub> =10V	--	17.4	--	nC
Q <sub>gs</sub>	Gate Source Charge	V <sub>DS</sub> = 720V	--	4.8	--	
Q <sub>gd</sub>	Gate Drain Charge	I <sub>D</sub> =4A	--	5.4	--	

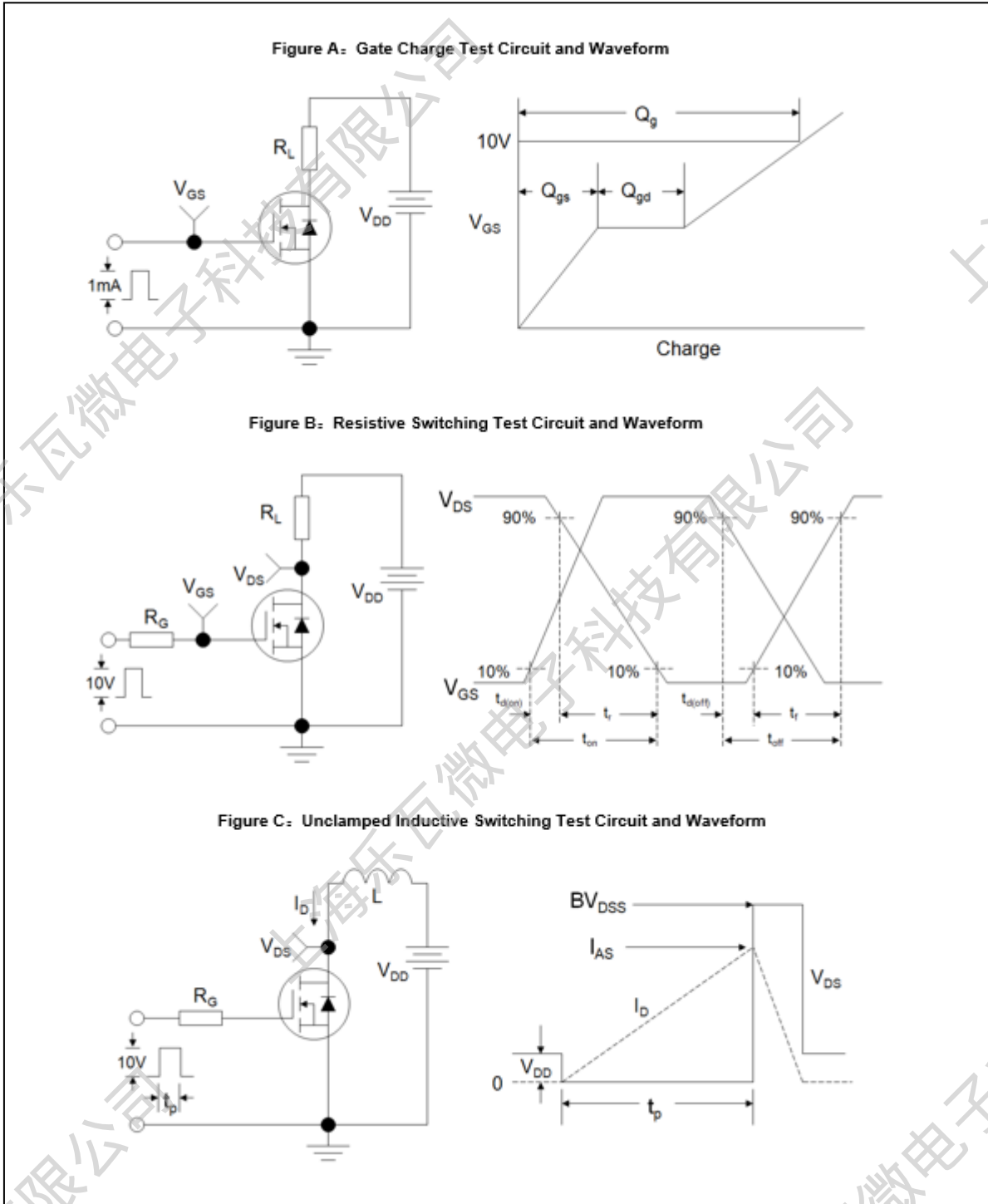
Source-Drain Diode Characteristics						
Symbol	Parameter	Test Conditions	Rating			Units
			Min.	Typ.	Max.	
$I_S$	Continuous Source Current (Body Diode)		--	--	4	A
$V_{SD}$	Diode Forward Voltage	$I_S=4.0A, V_{GS}=0V$	--	--	1.4	V
$t_{rr}$	Reverse Recovery Time	$I_S=4.0A, T_j = 25^\circ$	--	250	--	ns
$Q_{rr}$	Reverse Recovery Charge	$dI_F/dt=100A/\mu s, V_{GS}=0V$	--	1.5	--	$\mu C$
Pulse width $t_p \leq 380\mu s, \delta \leq 2\%$						

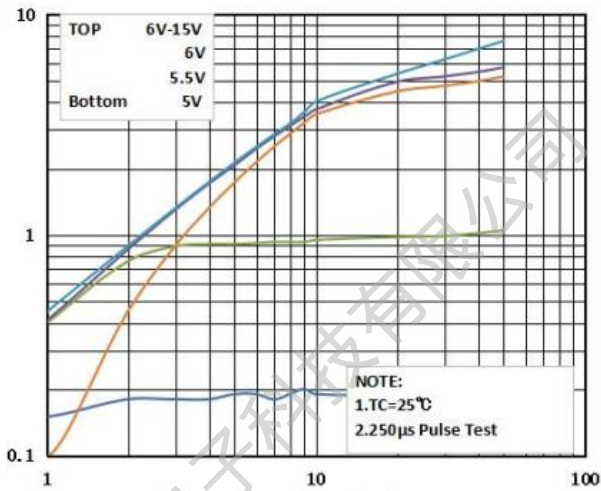
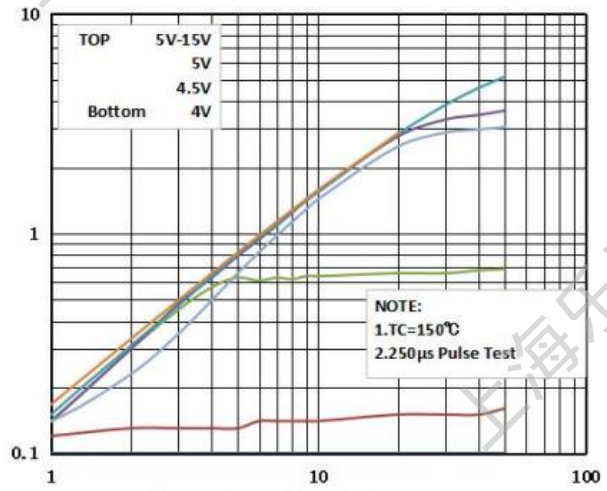
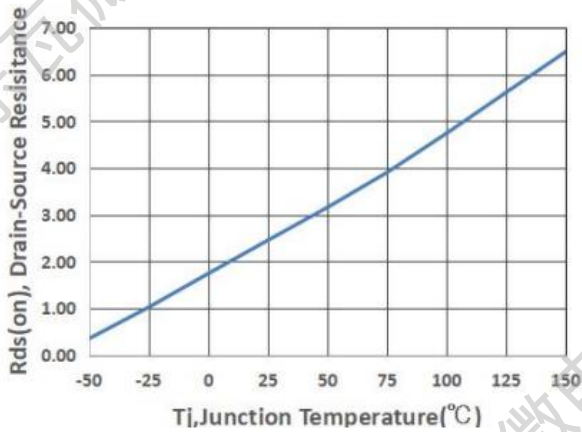
### Thermal Characteristics

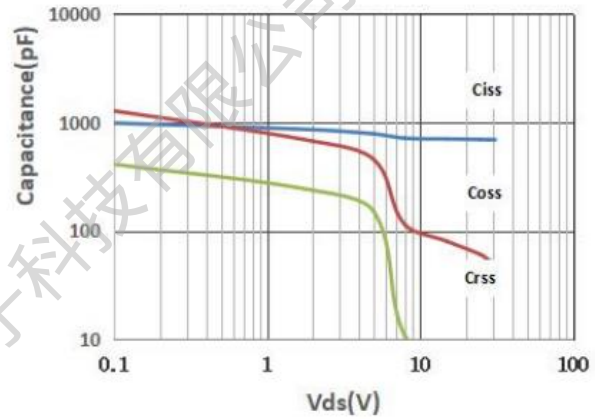
Symbol	Parameter	Typ.	Units
$R_{\theta JC}$	Junction-to-Case	3.47	$^\circ C/W$
$R_{\theta JA}$	Junction-to-Ambient	62.5	$^\circ C/W$

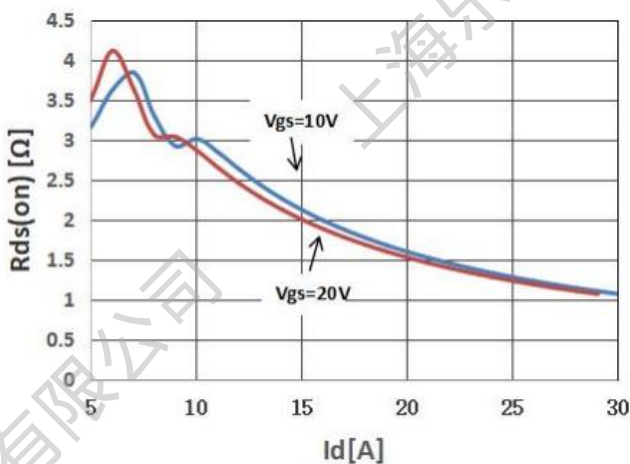
<sup>a1</sup>: Repetitive rating; pulse width limited by maximum junction temperature

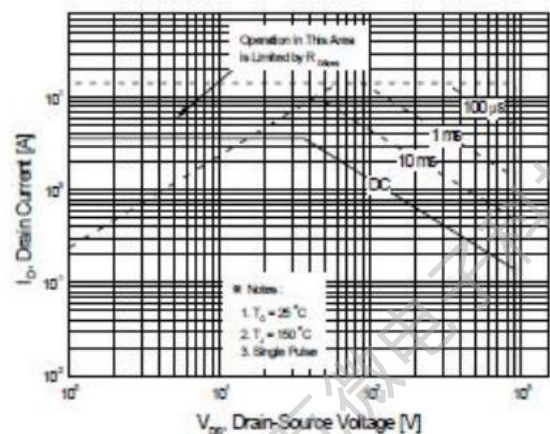
<sup>a2</sup>:  $L=30.0mH$ , Start  $T_j=25^\circ C$

**Test Circuit and Waveform**


**Typical Performance Characteristics**

**图 1** 输出特性曲线,  $T_c=25^\circ\text{C}$ 
**Fig1** Typical Output Characteristics,  $T_c=25^\circ\text{C}$ 

**图 2** 输出特性曲线,  $T_c=150^\circ\text{C}$ 
**Fig2** Typical Output Characteristics,  $T_c=150^\circ\text{C}$ 

**图 3** 导通电阻与温度曲线

**Fig3** Resistance Vs. Temperature

**图 4** 电容曲线

**Fig4** Capacitance vs  $V_{DS}$  Curve

**图 5** 导通电阻与漏极电流和栅极电压曲线

**Fig5** On-Resistance Vs. Drain Current and Gate Voltage

**图 6** 最大安全工作区曲线

**Fig6** Maximum Safe Operating Area

**Package Information**

**Revision History**

Revision	Date	Descriptions
REV.1.1	Sep, 2019	“Add Marking Iformation and Package Information” Update
REV.1.0	Feb, 2019	Initial Version

**DISCLAIMER:**

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